THIS DRAWING AND THE SUBJECT MATTER SHOWN THEREON ARE CONFIDENTIAL AND THE PROPERTY OF BEL/STEWART/TRP CONNECTOR AND SHALL NOT BE REPRODUCED, COPIED, OR USED IN ANY MANNER WITHOUT THE WRITTEN CONSENT OF TRP CONNECTOR. PRODUCT MAY BE PROTECTED BY ONE OR MORE OF THE FOLLOWING US PATENTS: 5736910 5939955 6425781 6428361 6554638 6840817 7123117 7429195 7717749 7808751 6217391 6149050 7924130 3 SEE LAST SHEET 250CT2019 CZ TY PLASTIC HOUSING: BLACK, THERMOPLASTIC FLAMMABILITY RATING UL 94V-0 SHIELD: BRASS OR STAINLESS STEEL, PREPLATED WITH 0.76 um MIN SEMI-BRIGHT NICKEL, POST DIPPED WITH 2.54 um MIN SAC SOLDER OR PURE TIN SOLDER DIP ON SOLDER TAILS CONTACTS: PHOSPHOR BRONZE, I.27um MIN OVERALL NICKEL UNDERPLATE WITH SELECT I.27um MIN GOLD AT MATING INTERFACE AND 2.54um MIN MATTE TIN ON SOLDER TAILS. MAGNETICS (PORTS A-D) D APPLICATION: GIGABIT BASE-T, 4PPOE IMPEDANCE: 100 OHMS TURNS RATIO (CHIP: CABLE): I:I ALL FOUR PAIRS OPEN CIRCUIT INDUCTANCE (OCL): ALL CHANNELS 350uH MIN @ 100KHz, O.I VRMS WITH 8mA DC BIAS, 120uH MIN @ 100KHz, O.I VRMS WITH 23mA DC BIAS ALL FOUR PAIRS BI-DIRECTIONAL POE CURRENT: IA DC MAX PERFORMANCE @ 25°C INSERTION LOSS (IL): I.IdB MAX FROM 0.5MHz TO 100MHz RETURN LOSS (RL): 18dB MIN FROM 0.5MHz TO 40MHz 12-20LOG(f/80)dB MIN FROM 40.IMHz TO 100MHz CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz 33-20LOG(f/50)dB MIN FROM 40.1MHz TO 100MHz COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz ISOLATION VOLTAGE: 2250VDC(MAX) FOR 60 SECONDS WITH A RISE TIME OF 500V/SEC AND WITH ALL PORTS CONNECTED. PART NUMBER, DATE CODE AND COUNTRY OF ORIGIN ARE LOCATED IN APPROXIMATE AREA SHOWN.
DATE CODE: YYWWD WHERE "YY" IS YEAR, "WW" IS WORK WEEK, "D" IS DAY OF WEEK, WITH SUNDAY = I 🛕 TRP CONNECTOR LOGO AND AGENCY APPROVAL LOGO ARE LOCATED IN APPROXIMATE AREA SHOWN. 5. OPERATING TEMP: FROM -40°C TO +85°C. 6. RJ45 CAVITY CONFORMS TO FCC RULES AND REGULATION PART 68 SUBPART F. ⚠ INDICATED MAGNETIC CONNECTIONS ARE SYMMETRICAL AND SUPPORT AUTO-MDI/MDIX. ⚠ DATUM AND BASIC DIMENSION ESTABLISHED BY CUSTOMER. BASIC DIMENSION ESTABLISHED BY CUSTOMER, BUT MAY NOT BE GREATER THAN 5.08mm. S9UG08ET GIGABIT 4PPOE CIRCUITAA S8G56ET GIGABIT CIRCUITAA IO. THE PARTS ARE RECOMMENDED FOR WAVE SOLDERING PROCESS, PEAK TEMPERATURE 260°C MAX, IO SECONDS MAX. (PORTS A-D) (PORTS E-H) M x 0 ⋅ TDO+ RJ-I (I) MXO-**-(2)** MX0+ MAGNETICS (PORTS E-H) APPLICATION: 10/100/1000 BASE-T TD0- RJ-2 IMPEDANCE: 100 OHMS TD0+RJ--(2) MX 0+ TURNS RATIO (CHIP:CABLE): I:I ALL FOUR PAIRS
OPEN CIRCUIT INDUCTANCE (OCL): 350uH MIN @100kHz, 0.1VRMS,
8mADC BIAS FROM-40°C TO +85°C, ALL FOUR PAIRS 3 MX I -سس TDI+ RJ-3 C2 MX I + -(3) MX I -TD0-RJ-2 ALL FOUR PAIRS BI-DIRECTIONAL PERFORMANCE @ 25°C: ICT: ICT TD2+ RJ-4 **(**4) MX I + TDI+|RJ-3 INSERTION LOSS (IL): I.IdB MAX FROM 0.5MHz TO 100MHz **(5)** MX2--ww-RETURN LOSS (RL): 18dB MIN FROM 0.5MHz TO 40MHz TD2- RJ-5 **6**) MX2+ Tuber 1 12-20LOG(f/80)dB MIN FROM 40.IMHz TO 100MHz -(5) MX2-TD2+RJ-4 CROSSTALK ATTENUATION: 35dB MIN FROM 0.5MHz TO 40MHz 33-20LOG(f/50)dB MIN FROM 40.1MHz TO 100MHz ICT: ICT - RJ-6 COMMON MODE REJECTION RATIO (CMRR): 30dB MIN FROM 0.5MHz TO 100MHz ISOLATION VOLTAGE: 2250VDC(MAX) FOR 60 SECONDS WITH A RISE TIME OF 500V/SEC AND WITH ALL PORTS CONNECTED. CMC3 TD2-RJ-5 -(6) MX2+ (7) MX3-TD3+ RJ-7 M X 3 + -ww -(7) M X 3 -TDI-|RJ-6 TD3- RJ-8 ICT: ICT **9** vcc T 4 -(8) MX3+ TD3+RJ-7 CMC4 ₽4 **^** _w__ (O) GND Tuus T -(9) vcc TD3-RJ-8 ICT: ICT **(1)** VC 45 SHIELD (10) GND 1 VC 1 2 CI CMCB 2250666-SHIELD PART NUMBER CI-C2 = IOnF, 50V, X7R, CAPACITORS C3-C6 = 22nF, IOOV, CAPACITORS HIS DRAWING IS A CONTROLLED DOCUMEN LOUD ZENG/TĚŘŘÝ ÚLI OMMY REN/BILL LIU 09SEP201 C7 = 1000pF, 2kV, CAPACITOR C8-C9=100nF, 100V, X7R, CAPACITOR CI = 1000pF, 2kV Capacitor C2 - C3 = 10nF, 50V Capacitors 4,S9UGO8ET GIGABIT 4PPOE 100W CIRCUI & S8G56ET Non-PoE CIRCUIT,W/O LED \bigoplus MAGJACK RI-R4 = 75 Ohms, I/I6W, RESISTORS RI-R4 = 75 Ohms, I/I6 W, Resistors STACK 4PPoE C-2250666 USTOMER DRAWING





